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Docket No.: Z&P-INFN10176

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : GABRIELA BRASE ET AL.

Filed : CONCURRENTLY HEREWITH

Title : ETCHING PROCESS FOR A TWO-LAYER METALLIZATION

INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications
are submitted herewith:

U.S. Patent 5,612,254 (Mu et al.), dated March 18, 1997;

U.S. Patent 5,635,423 (Huang et al.), dated June 3, 1997;

U.S. Patent 5,702,982 (Lee et al.), dated December 30, 1997;

U.S. Patent 5,726,100 (Givens), dated March 10, 1998;

U.S. Patent 5,773,199 (Linliu et al.), dated June 30, 1998;

U.S. Patent 5,801,094 (Yew et al.), dated September 1, 1998;

U.S. Patent 5,854,140 (Jaso et al.), dated December 29, 1998;

U.S. Patent 5,874,201 (Licata et al.), dated February 23, 1999;

European Patent Application EP 0 834 916 A2 (Boeck et al.), dated April 8, 1998;



European Patent Application EP 0 859 400 A2 (Yang et al.), dated August 19, 1998;

Patent Abstracts of Japan 09 134 862 A (Hiroshi), dated May 20, 1997

International Search Report, dated January 23, 2001.

Respectfully submitted,



For Applicants

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Date: February 11, 2002

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